Siliconix DG884

8 × 4 Wideband Video Crosspoint Array

Features

- Routes Any Input to Any Output
- Wide Bandwidth: 300 MHz
- Low Crosstalk: −85 dB @ 5 MHz
- Double Buffered TTL-Compatible Latches with Readback
- Low r_{DS(on)}: 45 Ω
- Optional Negative Supply

Benefits

- Reduced Board Space
- Improved System Bandwidth
- Improved Channel Off-Isolation
- Simplified Logic Interfacing
- Allows Bipolar Signal Swings
- Reduced Insertion Loss
- High Reliability

Applications

- Wideband Signal Routing and Multiplexing
- High-End Video Systems
- NTSC, PAL, SECAM Switchers
- Digital Video Routing
- ATE Systems

Description

The DG884 contains a matrix of 32 T-switches configured in an 8×4 crosspoint array. Any of the IN/OUT pins may be used as an input or output. Any of the IN pins may be switched to any or simultaneously to all OUT pins.

The DG884 is built on a proprietary D/CMOS process that combines low capacitance switching DMOS FETs with low power CMOS control logic and drivers. The ground lines between adjacent signal input pins help to reduce crosstalk. The low on-resistance and low on-capacitance of the DG884 make it ideal for video and wideband signal routing.

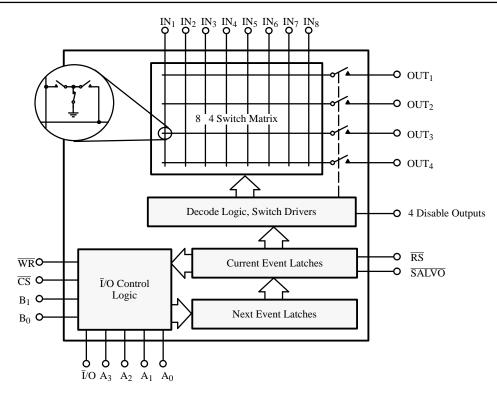
Control data is loaded individually into four Next Event latches. When all Next Event latches have been programmed, data is transferred into the Current Event latches via a SALVO command. Current Event latch data readback is available to poll array status.

Output disable capabilities make it possible to parallel multiple DG884s to form larger switch arrays. DIS outputs provide control signals used to place external buffers in a power saving mode.

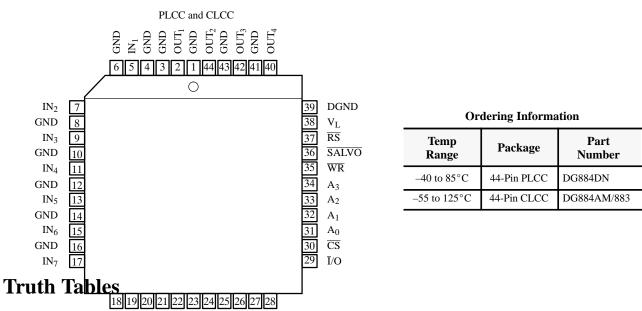
For additional information please refer to AN504.

Updates to this applications note may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70071.

Functional Block Diagram



Pin Configuration



RS	Ī/O	CS	WR	SALVO	Actions
1	0	1	Tdp Vie	w 1	No change to Next Event latches
1	0	0	Ł	1	Next Event latches loaded as defined in table below
1	0	0	0	1	Next Event latches are transparent.
1	0	0	.	1	Next Event data latched-in

Siliconix DG884

1	0	Х	1	7.	Data in all Next Event latches is simultaneously loaded into the Current Event latches, i.e., all new crosspoint addresses change simultaneously when SALVO goes low.
1	0	0	X	0	Current Event latches are transparent
1	0	X	1	<u>.</u>	Current Event data latched-in
1	0	0	0	0	Both next and Current Event latches are transparent
1	1	1	1	1	A_0, A_1, A_2, A_3 – High impedance
1	1	0	1	1	A ₀ , A ₁ , A ₂ , A ₃ become outputs and reflect the contents of the Current Event latches. B ₀ , B ₁ determine which Current Event latches are being read
0	X	X	1	1	All crosspoints opened (but data in Next Event latches is preserved)

All other states are not recommended.

Truth Tables (Cont'd)

WR	B ₁	B ₀	A ₃	A ₂	A ₁	A_0	Next Event Latches
	0	0	1	0 0 0 0 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0 1	IN_1 to OUT_1 Loaded IN_2 to OUT_1 Loaded IN_3 to OUT_1 Loaded IN_4 to OUT_1 Loaded IN_5 to OUT_1 Loaded IN_6 to OUT_1 Loaded IN_7 to OUT_1 Loaded IN_7 to OUT_1 Loaded IN_8 to OUT_1 Loaded
			0	X	X	X	Turn Off OUT ₁ Loaded
	0	1	1	0 0 0 0 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0 1	IN ₁ to OUT ₂ Loaded IN ₂ to OUT ₂ Loaded IN ₃ to OUT ₂ Loaded IN ₄ to OUT ₂ Loaded IN ₅ to OUT ₂ Loaded IN ₆ to OUT ₂ Loaded IN ₇ to OUT ₂ Loaded IN ₈ to OUT ₂ Loaded
			0	X	X	X	Turn Off OUT ₂ Loaded
0	1	0	1	0 0 0 0 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0 1	IN ₁ to OUT ₃ Loaded IN ₂ to OUT ₃ Loaded IN ₃ to OUT ₃ Loaded IN ₄ to OUT ₃ Loaded IN ₅ to OUT ₃ Loaded IN ₆ to OUT ₃ Loaded IN ₇ to OUT ₃ Loaded IN ₈ to OUT ₃ Loaded
			0	X	X	X	Turn Off OUT3 Loaded
	1	1	1	0 0 0 0 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0 1	IN_1 to OUT_4 Loaded IN_2 to OUT_4 Loaded IN_3 to OUT_4 Loaded IN_4 to OUT_4 Loaded IN_5 to OUT_4 Loaded IN_6 to OUT_4 Loaded IN_7 to OUT_4 Loaded IN_7 to OUT_4 Loaded IN_8 to OUT_4 Loaded
			0	X	X	X	Turn Off OUT ₄ Loaded

Note: When $\overline{WR}=0$ Next Event latches are transparent. Each crosspoint is addressed individually, e.g., to connect IN₁ to OUT₁ thru OUT₄

DG884 Siliconix

requires A_0 , A_1 , $A_2 = 0$ to be latched with each combination of B_0 , B_1 . When $\overline{RS} = 0$, all four \overline{DIS} outputs pull low simultaneously.

Absolute Maximum Ratings

V+ to GND	CURRENT (any terminal) Continuous 20 mA
V+ to V0.3 V to 21 V	CURRENT (S or D) Pulsed 1 ms 10% duty
V- to GND	Storage Temperature (A Suffix)
V _I to GND	(D Suffix) –65 to 125°C
	Operating Temperature (A Suffix) –55 to 125°C
Digital Inputs $(V-) - 0.3 \text{ V to } (V_L) + 0.3 \text{ V}$	(D Suffix)40 to 85°C
or 20 mA, whichever occurs first	Power Dissipation (Package) ^a
V_S,V_D (V–) – 0.3 V to (V–) + 14 V	44-Pin Quad J Lead PLCC ^b
or 20 mA, whichever occurs first	44-Pin Quad J Lead Hermetic CLCC ^c

- a. All leads soldered or welded to PC board.
- b. Derate 6 mW/°C above 75°C.c. Derate 16 mW/°C above 75°C.

$Specifications ^{a} \\$

			Test Conditions Unless Otherwise Specified		A Suffix -55 to 125°C		D Suffix -40 to 85°C			
Parameter	Symbol	$V+=15 \text{ V}, V-=-3 \text{ V}$ $V_L=5 \text{ V}, \overline{\text{RS}}=2.0 \text{ V}$ $\overline{\text{SALVO}}, \overline{\text{CS}}, \overline{\text{WR}}, \overline{\text{I/O}}=0.8 \text{ V}$	Temp b	Турс	Min d	Max ^d	Min d	Max ^d	Unit	
Analog Switch										
Analog Signal Range ^e	V _{ANALOG}	V-=-5 V	Full		-5	8	-5	8	V	
Drain-Source On-Resistance	r _{DS(on)}	$I_S = -10 \text{ mA}, V_D = 0 \text{ V}$ $V_{AIH} = 2.0 \text{ V}, V_{AIL} = 0.8 \text{ V}$	Room Full	45		90 120		90 120	Ω	
Resistance Match Between Channels	$\Delta r_{\mathrm{DS(on)}}$	Sequence Each Switch On	Room	3		9		9	52	
Source Off Leakage Current	$I_{S(off)}$	$V_S = 8 \text{ V}, V_D = 0 \text{ V},$ $\overline{RS} = 0.8 \text{ V}$	Room Full		-20 -200	20 200	-20 -200	20 200		
Drain Off Leakage Current	$I_{D(off)}$	$V_S = 0 \text{ V}, V_D = 8 \text{ V}, \\ \overline{RS} = 0.8 \text{ V}$	Room Full		-20 -200	20 200	-20 -200	20 200	nA	
Total Switch On Leakage Current	I _{D(on)}	$V_S = V_D = 8 V$	Room Full		-20 -200 0	20 2000	-20 -200	20 200		
Digital Input/Output	•									
Input Voltage High	V_{AIH}		Full		2		2		v	
Input Voltage Low	$V_{ m AIL}$		Full			0.8		0.8	`	
Address Input Current	I_{AI}	V _{AI} = 0 V or 2 V or 5 V	Room Full	0.1	-1 -10	1 10	-1 -10	1 10		
Address Output Current	I_{AO}	$V_{AO} = 2.7 \text{ V}$, See Truth Table	Room	-600		-200		-200	μΑ	
Address Output Current		$V_{AO} = 0.4 \text{ V}$, See Truth Table	Room	1500	500		500			
DIS Pin Sink Current	I_{DIS}		Room	1.5					mA	

Siliconix DG884

On State Input Capacitance ^e	C	1 In to 1 Out, See Figure 11	Room	30		40	
On State input Capacitance	$C_{S(on)}$	1 In to 4 Out, See Figure 11	Room	120		160	рF
Off State Input Capacitance ^e	$C_{S(off)}$	See Figure 11	Room	8	20	20	pr.
Off State Output Capacitance ^e	C _{D(off)}	See Figure 11	Room	10	20	20	
Transition Time	t _{TRANS}	See Figure 5	Room			300	
Break-Before-Make Interval	t _{OPEN}	See Figure 5	Full		10	10	
SALVO, WR Turn On Time	t _{ON}	R_L = 1 k Ω , C_L = 35 pF 50% Control to 90% Output	Room Full		300 500	300	ns
SALVO, WR Turn Off Time	t _{OFF}	See Figure 3	Room Full		175 300	175	
Charge Injection	Q	See Figure 6	Room	-100			pC
Matrix Disabled Crosstalk	X _{TALK(DIS)}	$R_{IN} = R_L = 75 \Omega$ f = 5 MHz, See Figure 10	Room	-82			
Adjacent Input Crosstalk	X _{TALK} (AI)	$R_{IN} = 10 \Omega$, $R_L = 10 k\Omega$ f = 5 MHz, See Figure 9	Room	-85			dB
All Hostile Crosstalk	X _{TALK(AH)}	$R_{IN} = 10 \Omega$, $R_L = 10 k\Omega$ f = 5 MHz, See Figure 8	Room	-66			
Bandwidth	BW	$R_L = 50 \Omega$, See Figure 7	Room	300			MHz

$Specifications^{a} \\$

		Test Conditions Unless Otherwise Specified				uffix 125°C		uffix o 85°C	
Parameter	Symbol	$V+ = 15 \text{ V}, V- = -3 \text{ V} \\ V_L = 5 \text{ V}, \overline{\text{RS}} = 2.0 \text{ V} \\ \overline{\text{SALVO}}, \overline{\text{CS}}, \overline{\text{WR}}, \overline{\text{I/O}} = 0.8 \text{ V}$	Temp b	Турс	Min d	Max ^d	Min d	Max ^d	Unit
Power Supplies									
Positive Supply Current	I+		Room Full	1.5		3 6		3 6	mA
Negative Supply Current	I–	All Inputs At GND or 2 V $\overline{RS} = 2 \text{ V}$	Room Full	-1.5	-3 -5		-3 -5		IIIA
Digital GND Supply Current	I_{DG}		Full	-275	-750		-750		
Logic Supply Current	$I_{ m L}$		Full	200		500		500	μA
	V+ to V-	See Operating Voltage Range	Full		13	20	13	20	
Functional Operating Supply Voltage Range ^e	V- to GND	(Typical Characteristics)	Full		-5.5	0	-5.5	0	V
	V+ to GND	page 7	Full		10	20	10	20	
Minimum Input Timing R	equirements								
Address Write Time	t_{AW}		Full	20	50		50		
Minimum WR Pulse Width	t_{WP}		Full	50	100		100		1
Write Address Time	t _{WA}		Full	-10	10		10		1
Chip Select Write Time	t _{CW}		Full	50	100		100		1
Write Chip Select Time	t _{WC}		Full	25	75		75		1
Minimum SALVO Pulse Width	t _{SP}		Full	50	100		100		
SALVO Write Time	t_{SW}	See Figure 1	Full	-10	10		10		ns
Write SALVO Time	t _{WS}	-	Room	20			50		1
Input Output Time	t _{IO}		Room	150	200		200		1
Address Output Time	t _{AO}		Room	150	200		200		1
Chip Select Output Time	t _{CO}		Room	150	200		200		1
Chip Select Address Time	t_{CA}		Room	60			100		1
Reset to SALVO	t _{RS}		Full		50		50		1
Ī/O Address Input Time	t_{IA}		Room	50					1

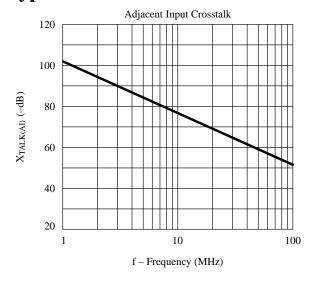
- a. Refer to PROCESS OPTION FLOWCHART (Section 5 of the 1994 Data Book or FaxBack number 7103).
- Room = 25°C, Full = as determined by the operating temperature suffix.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

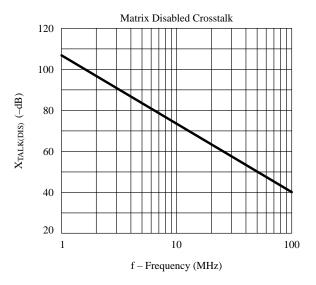
 The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.

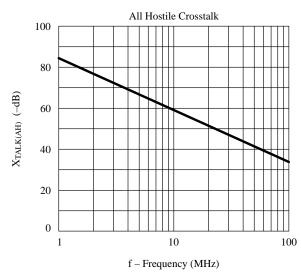
Guaranteed by design, not subject to production test.

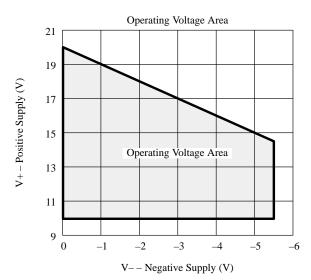
Siliconix DG884

Typical Characteristics









Timing Diagrams and Parameter Definitions

Symbol	Parameter	Description
T_{AW}	Address to Write	Minimum time address must be valid before WR goes high
T_{WA}	Write to Address	Minimum time address must remain valid after WR pulse goes high
$T_{ m WP}$	WR Pulse	Minimum time of \overline{WR} pulse width to write address into Next Event latches
T_{CW}	Chip Select to WR	Minimum time chip select must be valid before a WR pulse
$T_{ m WC}$	WR to Chip Select	Minimum time chip select must remain valid after \overline{WR} pulse
T_{SP}	SALVO Pulse	Minimum time of SALVO pulse width
T_{WS}	WR to SALVO	Minimum time from WR pulse to SALVO to load new address
T_{SW}	SALVO to WR	Minimum time from SALVO pulse to WR to load current address
T_{IA}	Ī/O to Address In	Minimum time I/O must be valid before address applied

Timing Diagrams and Parameter Definitions (Cont'd)

Symbol	Parameter	Description
T_{RS}	RS to SALVO	Minimum time RS must be valid before SALVO pulse
T_{IO}	Ī∕O to Output	Minimum time \overline{I}/O must be valid before address output valid
T _{AO}	Address to Output	Minimum time address B_X must be valid until address A_X output valid
T _{CO}	CS to Output	Minimum time $\overline{\text{CS}}$ must be valid until A_X output is valid
T _{CA}	CS to Address In	Minimum time $\overline{\text{CS}}$ must be valid before address applied if $\overline{\text{I}}/\text{O}$ is high

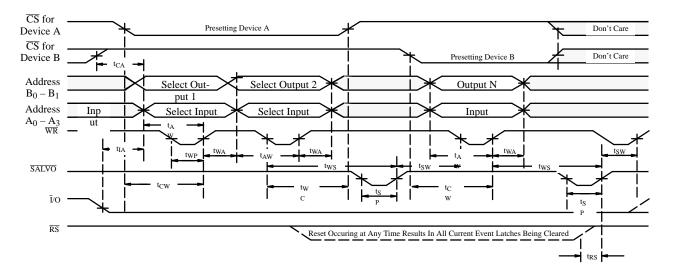


Figure 1. Input Timing Requirements

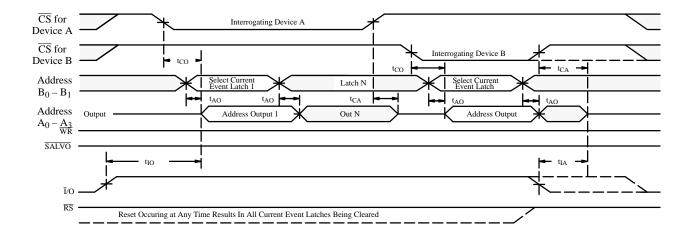


Figure 2. Output Timing Requirements

Siliconix DG884

Test Circuits

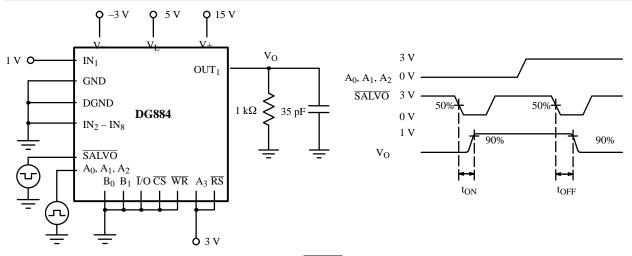


Figure 3. SALVO Turn On/Off Time

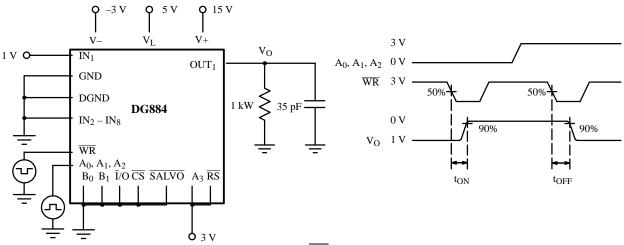


Figure 4. WR Turn On/Off Time

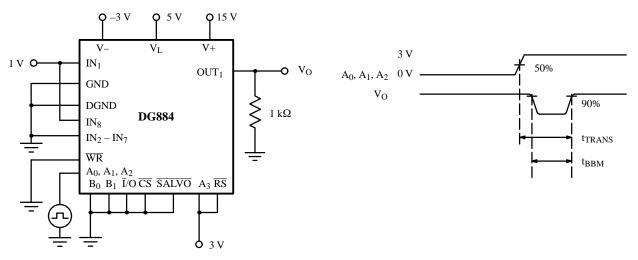


Figure 5. Transition Time and Break-Before-Make Interval

Siliconix DG884

Test Circuits

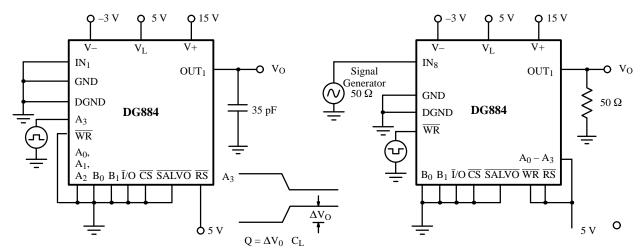


Figure 6. Charge Injection

Figure 7. −3 dB Bandwidth

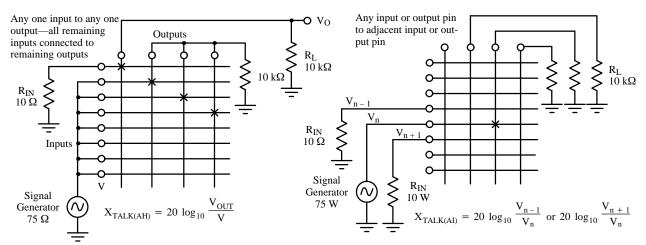


Figure 8. All Hostile Crosstalk

Figure 9. Adjacent Input Crosstalk

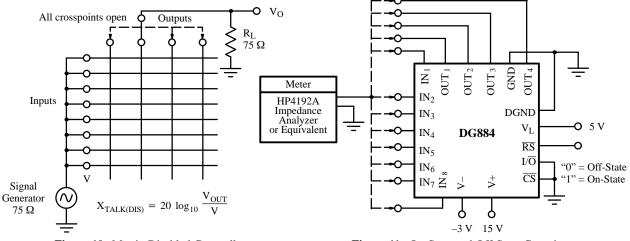


Figure 10. Matrix Disabled Crosstalk

Figure 11. On-State and Off-State Capacitances

Pin Description

Pin	Symbol	Description
1, 3, 4, 6, 8, 10, 12, 14, 16, 18, 20, 41, 43	GND	Analog Signal Ground
39	DGND	Digital Ground
26	V+	Positive Supply Voltage
21	V-	Negative Supply Voltage
38	$V_{ m L}$	Logic Supply Voltage—generally 5 V
5, 7, 9, 11, 13, 15, 17, 19	IN ₁ to IN ₈	8 Analog Input Channels
2, 40, 42, 44	OUT ₁ to OUT ₄	4 Analog Output Channels
29	Ī/O	Determines whether data is being written into the Next Event latches or read from the Current Event latches
30	CS	Chip Select—a logic input
31, 32, 22, 24	A_0, A_1, A_2, A_3	IN Address—logic inputs or outputs as defined by I/O pin, select one of eight IN channels
27, 28	B ₀ , B ₁	OUT Address—logic inputs, select one of four OUT channels
35	WR	Write command that latches A ₀ , A ₁ , A ₂ , A ₃ into the Next Event latches
36	SALVO	Master write command, that in one action, transfers all the data from Next Event latches into Current Event latches
37	RS	Reset—a low will clear the Current Event latches
22, 23, 24, 25	$\overline{\rm DIS}_1$ to $\overline{\rm DIS}_4$	Open drain disable outputs—these outputs pull low when the corresponding OUT channel is off

Device Description

The DG884 is the world's first monolithic wideband crosspoint array that operates from dc to >100 MHz. The DG884 offers the ability to route any one of eight input signals to any one of four OUT pins. Any input can be routed to one, two, three or four OUTs simultaneously with no risk of shorting inputs together (guaranteed by design).

Each crosspoint is configured as a "T" switch in which DMOS FETs are used due to their excellent low resistance and low capacitance characteristics. Each OUT line has a series switch that minimizes capacitive loading when the OUT is off.

Interfacing

The DG884 was designed to allow complex matrices to be developed while maintaining a simple control interface. The status of the \overline{I}/O pin determines whether the DG884 is being written to or read from (see Figures 1 and 2).

In order to WRITE to an individual latch, \overline{CS} and \overline{I}/O need to be low, while \overline{RS} , \overline{WR} and \overline{SALVO} must be high. The IN to OUT path is selected by using address A_0 through A_3 to define the IN line and address B_0 and B_1 to define

the OUT line. That is, The IN defined by A_0 through A_3 is electrically connected to the OUT defined by B_0 , B_1 . This chosen path is loaded into the Next Event latches when \overline{WR} goes low and returns high again. This operation is repeated up to three more times if other crosspoint connections need to be changed.

Upon completing all crosspoint connections that are to be changed in a single device, other DG884s can be similarly preset by taking the $\overline{\text{CS}}$ pin low on the appropriate device. When all DG884s are preset, the Current Event latches are simultaneously changed by a single $\overline{\text{SALVO}}$ command applied to all devices. In this manner the crosspoint configuration of any number of devices can be simultaneously updated.

DIS Outputs

Four open drain disable OUTs are provided to control external line drivers or to provide visual or electrical signaling. For example, any or all of the $\overline{\text{DIS}}$ OUTs can directly interface with a Siliconix Si582 Video Amplifier to place it into a high impedance, low-power standby mode when the corresponding OUT is not being used. (See Figure 15). The $\overline{\text{DIS}}$ outputs are low and sink to V—when corresponding OUT is open or $\overline{\text{RS}}$ is low.

Siliconix DG884

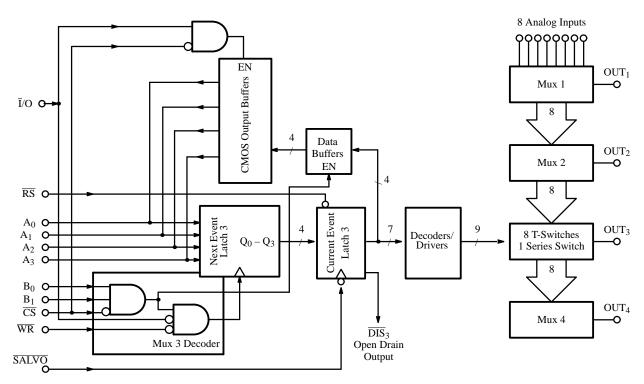
Device Description (Cont'd)

Reset

The reset function (\overline{RS}) allows the resetting of all crosspoints to a known state (open). At power up, the reset facility may be used to guarantee that all switches are open. It should be noted that \overline{RS} clears the Current Event latches, but the Next Event latches remain unchanged. This useful facility allows the user to return the matrix to its previous state (prior to reset) by simply applying the \overline{SALVO} command. Alternatively, the user can reprogram the Next Event latches, and then apply the \overline{SALVO} command to reconfigure the matrix to a new state.

Readback

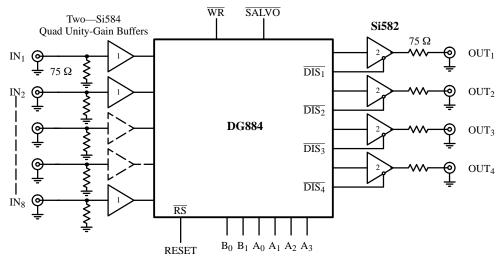
The I/O facility enables the user to write data to the Next Event latches or to read the contents of the Current Event latches. This feature permits the central controller to periodically monitor the state of the matrix. If a power loss to the controller occurs, the readback feature helps the matrix to recover rapidly. It also offers a means to perform PC board diagnostics both in production and in system operation.



One of Four Blocks of Logic/Latches Shown

Figure 12. Control Circuitry

Applications



Note: $\overline{\text{DIS}}$ outputs are used to power down the Si582 amplifiers.

Figure 13. Fully Buffered 8 4 Crosspoint

Power Supplies and Decoupling

A useful feature of the DG884 is its power supply flexibility. It can be operated from dual supplies, or a single positive supply (V– connected to 0 V) if required. Allowable operating voltage ranges are shown in Operating Voltage Range (Typical Characteristics) graph, page 7.

Note that the analog signal must not go below V- by more than 0.3~V (see absolute maximum ratings). However, the addition of a V- pin has a number of advantages:

- 1) It allows flexibility in analog signal handling, i.e. with V-=-5 V and V+=15 V, up to ± 5 V ac signals can be accepted.
- 2) The value of on-capacitance $(C_{S(on)})$ may be reduced by increasing the value of V-. It is useful to note that optimum video differential phase and gain occur when V- is -3 V. Note that V+ has no effect on $C_{S(on)}$.
- V- eliminates the need to bias an ac analog signal using potential dividers and large decoupling capacitors.

It is established RF design practice to incorporate sufficient bypass capacitors in the circuit to decouple the power supplies to all active devices in the circuit. The dynamic performance of the DG884 is adversely affected by poor decoupling of power supply pins. Also, since the substrate of the device is connected to the negative supply, proper decoupling of this pin is essential.

Rules:

- 1) Decoupling capacitors should be incorporated on all power supply pins $(V+, V-, V_L)$.
- 2) They should be mounted as close as possible to the device pins.
- 3) Capacitors should have good high frequency characteristics—tantalum bead and/or monolithic ceramic disc types are suitable.

Recommended decoupling capacitors are 1- to $10-\mu F$ tantalum bead, in parallel with 100-nF monolithic ceramic.

4) Additional high frequency protection may be provided by $51-\Omega$ carbon film resistors connected in series with the power supply pins (see Figure 14).

Siliconix DG884

Applications (Cont'd)

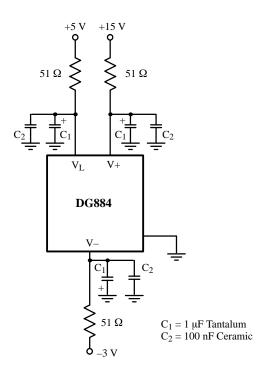


Figure 14. DG884 Power Supply Decoupling

The V_L pin permits interface to various logic types. The device is primarily designed to be TTL or CMOS logic compatible with +5 V applied to V_L . The actual logic threshold can be raised simply by increasing V_L .

A typical switching threshold versus V_L is shown in Figure 15.

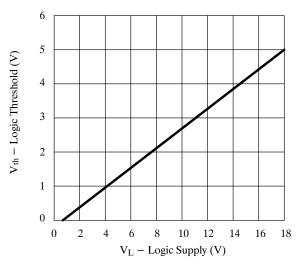


Figure 15. Switching Threshold Voltage vs. V_L

These devices feature an address readback facility whereby the last address written to the device may be read by the system. This allows improved status monitoring and hand shaking without additional external components.

When the \overline{I}/O assigns the address output condition, the A_X address pins can sink or source current for logic low and high, respectively. Note that V_L is the logic high output condition. This point must be respected if V_L is varied for input logic threshold shifting.

Note: Even though these devices are designed to be latchup resistant, V_L must not exceed V_+ by more than 0.3 V in operation or during power supply on/off sequencing.

Layout

The PLCC package pinout is optimized so that large crosspoint arrays can be easily implemented with a minimum number of PCB layers (see Figure 16). Crosstalk is minimized and off-isolation is optimized by having ground pins located adjacent to each input and output signal pins. Optimum off-isolation and low crosstalk performance can only be achieved by the proper use of RF layout techniques: avoid sockets, use ground planes, avoid ground loops, bypass the power supplies with high frequency type capacitors (low ESR, low ESL), use striplines to maintain transmission line impedance matching.

For additional information please refer to Application Note AN504.

DG884 Siliconix

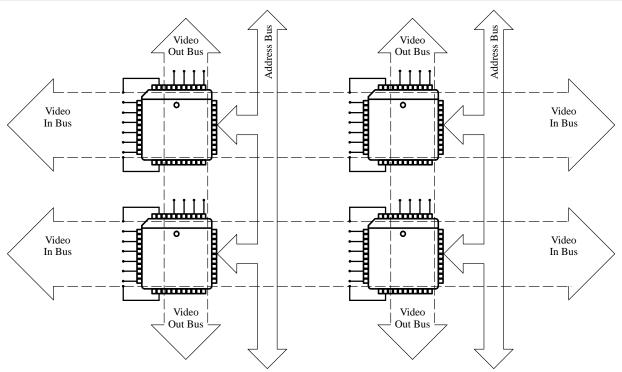


Figure 16. 16 X 8 Expandable Crosspoint Matrix Using DG884